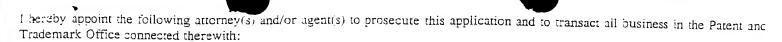
## Declaration for U.S. Patent Application

|  |   |  | I I  |   |
|--|---|--|--|---|
| As a below nan   | ned inventor, I hereby dec  | lare that:   |  |   |
| My residence, p  | post office address and citi  | izenship are as stated   | below next to my name.   |   |
| (Insert Title)   | ne original, first and sole is below) of the subject man Longitudinal Coupler of which is attached here | ed Multiple Moo  | and for which a patent is sough<br>de Surface Acoustic Wa  | ginal, first and joint inventor (if plural at on the invention entitled ve Filter   |
|  | was filed on  | as United S<br>and was amended   | tates Application Number or Po   | CT International Application Number (if applicable).  |
| I hereby state the amended by any                                  | at I have reviewed and und<br>amendment referred to ab  | derstand the contents ove.   | of the above-identified specifica  | ation, including the claim(s), as   |
| I acknowledge th<br>Regulations, § 1.                              | e duty to disclose informa<br>56.   | tion which is materia  | l to patentability as defined in T   | Fitle 37, Code of Federal   |
|  | reign priority benefits und<br>ificate listed below and ha<br>te before that of the applic              | ive also identifien her  | OW any foreign application for .   |   |
| (List prior foreign applications. See note A on back of this page) | 039418/2001   | JAPAN  | 16/02/2001   | Priority Claimed X Yes No   |
|  | (Number)<br>016189/2002   | (Country) (1<br>2 JAPAN  | Day/Month/Year Filed)<br>24/01/2002  | X Yes No  |
|  | (Number)  | (Country) (I   | Day/Month/Year Filed)  |   |
|  | (Number)  | (Country) (I   | Day/Month/Year Filed)  | Yes No  |
|  | (Number)  | (Country) (E   | Day/Month/Year Filed)  | Yes No  |
| (See note B on bac   | k of this page)   | See attached lis   | st for additional prior foreign a  | pplications   |
| the first paragraph patentability as def                           | of Title 35, United State   | ited States Code, § 12<br>plication is not disclo<br>es Code, § 112, I ac<br>Federal Regulations | 0 of any United States applications of any United States applications of the prior of the pri | on(s) listed below and, insofar as the oplication in the manner provided by e information which is material to between the filing date of the prior |
| Applications)  | (Appln. Serial No.)   | (Filing Date)  | (Status: Patented, Pending,  | Abandoned)  |
|  | (Appln. Serial No.)   | (Filing Date)  | (Status: Patented, Pending, A  | Abandoned)  |

(Filing Date)

(Status: Patented, Pending, Abandoned)

(Appin. Serial No.)





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Please direct all communications to the following address:



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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| (See note C          | Full name of sole or first inventor (giv     | ren name, family name) <u>Naoki TANAKA</u>  |
|----------------------|--|---|
| above)               | Inventor's signature 1                       | Date From 1 2002                            |
|                      | Residence OSAKA, JAPAN                       | Citizenship <u>JAPANESE</u>                 |
|                      | Post Office Address 4-1-1-108,<br>Sakai-shi, | Minami-machi 3-chome, Hamadera OSAKA, JAPAN |
|                      | nd inventor (given name, family name)        | Tatsuro USUKI                               |
| Inventor's signatur  | e Jostsuro Uzulti                            | Date <u>Feb. 4, 2002</u>                    |
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| Full name of third   | inventor (given name, family name)           |   |
| Inventor's signature | e  | Date  |
|                      |  | Citizenship                                 |
| Post Office Addres   | s  |   |
|                      |  | - · · · · · · · · · · · · · · · · · · ·     |
| 'nventor's signature | e  | Date  |
| Residence            |  | Citizenship                                 |
| Post Office Address  | s  |   |
|                      |  |   |
| nventor's signature  | 9  | Date  |
| Residence            |  | Citizenship                                 |
|                      |  |   |
|                      |  |   |
|                      |  | Date  |
|                      |  | Citizenship                                 |
|                      |  |   |
|                      |  |   |
|                      |  | Date  |